

DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
001/	40mΩ @ V _{GS} = 4.5V	5.0A
30V	75mΩ @ V _{GS} = 2.5V	3.6A

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

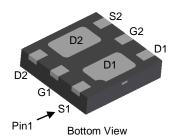
Description and Applications

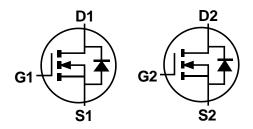
This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Battery Charging
- Power Management Functions
- DC-DC Converters
- Portable Power Adaptors

Mechanical Data

- Case: U-DFN2020-6 (Type B)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Weight: 0.0065 grams (Approximate)





Internal Schematic

Ordering Information (Note 4)

Part Number	Case	Packaging
DMN3055LFDB -7	U-DFN2020-6 (Type B)	3,000/Tape & Reel
DMN3055LFDB -13	U-DFN2020-6 (Type B)	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



M6 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: E = 2017) M = Month (ex: 9 = September)

Date Code Key

Year	2016		2017	2018		2019	2020		2021	2022		2023
Code	D		Е	F		G	Н		I	J		K
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage	V_{DSS}	30	V		
Gate-Source Voltage	V _{GSS}	±12	V		
Continuous Drain Current (Note 6) $V_{GS} = 4.5V$ Steady $T_A = +25^{\circ}C$ State $T_A = +70^{\circ}C$			I _D	5.0 4.0	А
Maximum Continuous Body Diode Forward Current	I _S	1.5	Α		
Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%	6)	I _{DM}	25	Α	
Avalanche Current (Note 7) L = 0.1mH	I _{AS}	11	Α		
Avalanche Energy (Note 7) L = 0.1mH		E _{AS}	6	mJ	

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	D-	0.81	W
Total Fower Dissipation (Note 5)	T _A = +70°C	P_{D}	0.52	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Б	132	°C/W
Thermal Resistance, Junction to Ambient (Note 3)	t<10s	$R_{ heta JA}$	101	
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	PD	1.36	W
Total Fower Dissipation (Note o)	$T_A = +70^{\circ}C$	۲۵	0.87	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	D	83	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	60	
Thermal Resistance, Junction to Case (Note 6)	$R_{ heta JC}$	10		
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

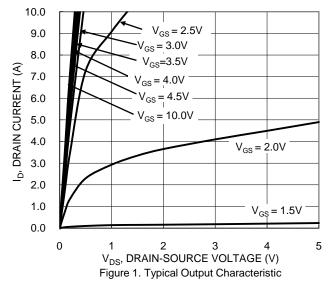
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)	1 2	ı	, ,,			
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current, T _J = +25°C	I _{DSS}	_	_	1.0	μΑ	V _{DS} = 30V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(TH)}	0.5	_	1.5	٧	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
Static Drain-Source On-Resistance		_	32	40	mΩ	$V_{GS} = 4.5V, I_D = 3A$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	52	75	11122	$V_{GS} = 2.5V, I_D = 2A$
Diode Forward Voltage	V _{SD}	_	0.8	1.2	V	$V_{GS} = 0V$, $I_S = 2A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C _{iss}	-	458	-	рF	\\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
Output Capacitance	Coss	_	50	-	рF	$V_{DS} = 15V, V_{GS} = 0V,$ - f = 1.0MHz
Reverse Transfer Capacitance	C_{rss}	_	44	_	pF	1 = 1.01/11/12
Gate Resistance	Rg	-	2.1	-	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = 10V)	Q_g	_	11.2	_	nC	
Total Gate Charge (V _{GS} = 4.5V)	Qg	-	5.3	-	nC	\/ 45\/ I- 4A
Gate-Source Charge	Qgs	_	1.1	-	nC	$V_{DS} = 15V, I_{D} = 4A$
Gate-Drain Charge	Q_{gd}	_	1.8	_	nC	
Turn-On Delay Time	t _{D(ON)}	_	1.8	_	ns	
Turn-On Rise Time	t _R	_	2.6	_	ns	VDS = 15V, VGS = 10V,
Turn-Off Delay Time	t _{D(OFF)}	_	9.5	_	ns	$R_g = 6\Omega$, $R_L = 3.75\Omega$,
Turn-Off Fall Time	t _F	_	2.1	_	ns	
Reverse Recovery Time	t _{RR}	_	7.0	_	ns	1 24 4:/44 4004/
Reverse Recovery Charge	Q _{RR}	_	1.8	_	nC	$I_F = 3A$, di/dt = 100A/ μ s

Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
- 7. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
- 8. Short duration pulse test used to minimize self-heating effect.9. Guaranteed by design. Not subject to product testing.







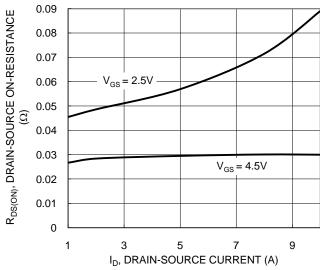


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

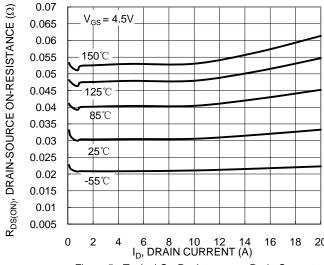


Figure 5 . Typical On-Resistance vs. Drain Current and Temperature

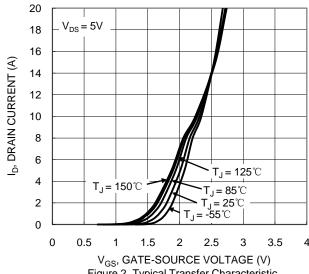


Figure 2. Typical Transfer Characteristic

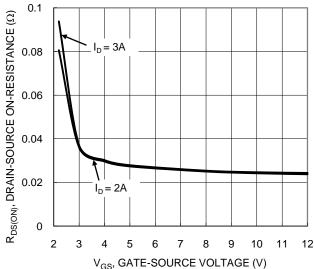


Figure 4 . Typical Transfer Characteristic

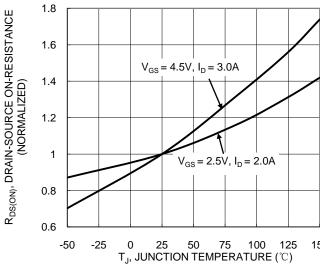


Figure 6. On-Resistance Variation with Temperature



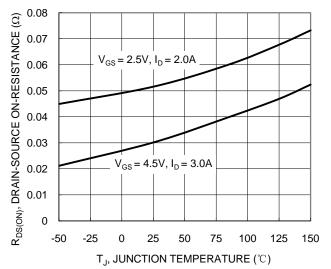


Figure 7. On-Resistance Variation with Temperature

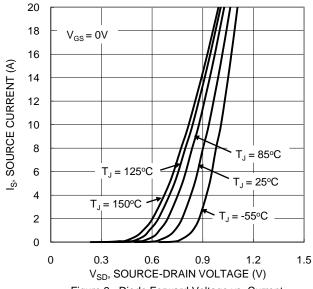
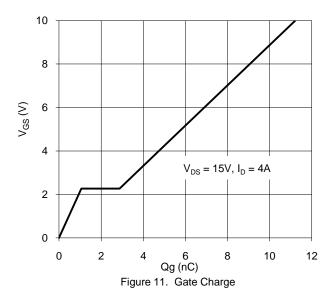


Figure 9. Diode Forward Voltage vs. Current



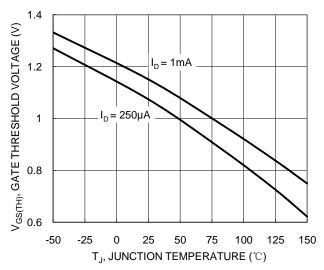
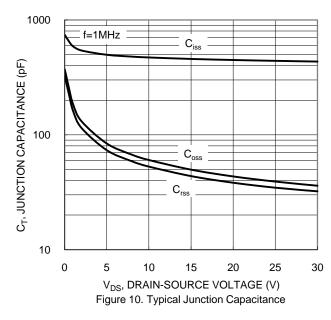
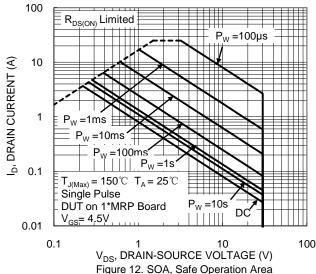


Figure 8. Gate Threshold Variation vs. Junction Temperature







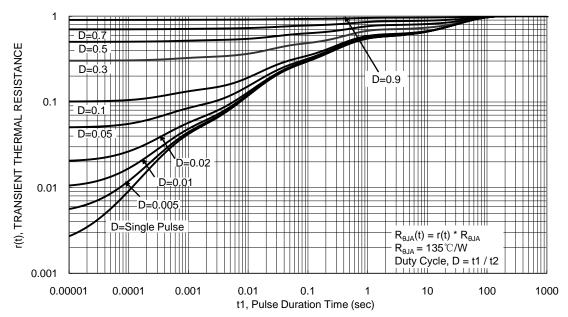


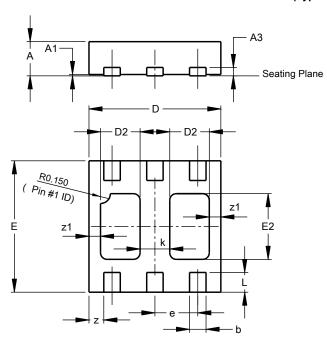
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type B)

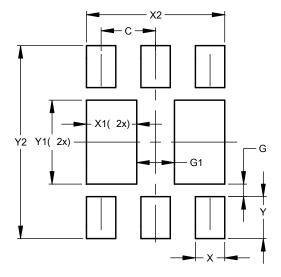


U-DFN2020-6									
Dim	(Type B) Dim Min Max Typ								
Α	0.545	0.605	0.575						
A1	0.00	0.05	0.02						
A3	-	-	0.13						
b	0.20	0.30	0.25						
D	1.95	2.075	2.00						
D2	0.50	0.70	0.60						
е	-	-	0.65						
Е	1.95	2.075	2.00						
E2	0.90	1.10	1.00						
k	-	-	0.45						
L	0.25	0.35	0.30						
z	-	-	0.225						
z1	-	-	0.175						
All Dimensions in mm									

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type B)



Dimensions	Value			
Dillielisions	(in mm)			
C	0.650			
G	0.150			
G1	0.450			
X	0.350			
X1	0.600			
X2	1.650			
Y	0.500			
Y1	1.000			
Y2	2 300			



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